

SPECIFICATION

2G/3G/4G LTE Chip Antenna



Model No.: UCCL02



1. General Description

1.1 Electrical Properties

Parameter	Description				
Frequency Band	698~960/1710~2690 MHz				
Nominal Impedance	50 Ω				
Polarization	Linear				
V.S.W.R.	<3.5:1				
(MHz)	698~798	824~960	1710~2170	2300~2400	2490~2690
Efficiency (%)	54	58	55	75	65
Peak Gain (dBi)	1.3	1	2.6	4.4	4.2
※With 37 x 118.5 mm Evaluation Board & 37 x 11.4 mm Clearance Area					

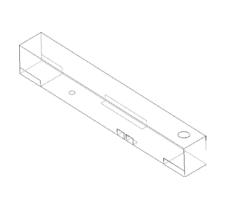
1.2 Mechanical Properties

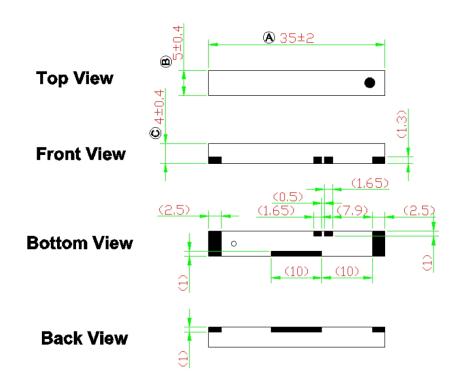
Parameter	Description
Dimensions	35*5*4 mm
Operating Temperature	-40°C~85°C
Storage Temperature (With Packing Sealed)	-5°C~40°C

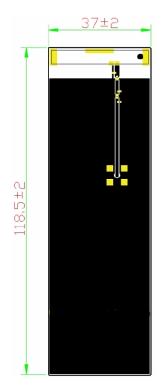


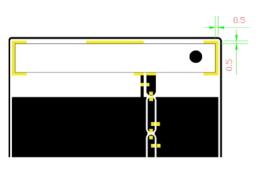
2. Appearance

2.1 Dimensions Of Antenna And Evaluation Board (Unit: mm)



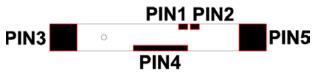








2.2 PIN Definitions



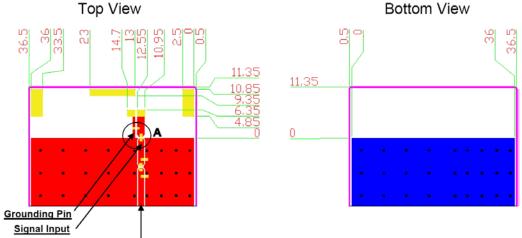
Bottom View

Item	PIN 1	PIN 2	PIN 3~5
Soldering Pad	Soldering Pad Tuning / Ground		N/C

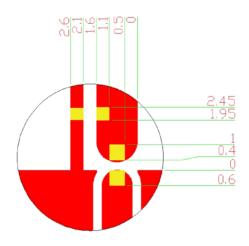
3. Layout Guide (Unit: mm)

The solder land pattern (yellow marking areas) is shown as below. Recommendation on matching circuit will be provided according to customer's installation conditions.

With 37 x 118.5 mm Evaluation Board /iew Board

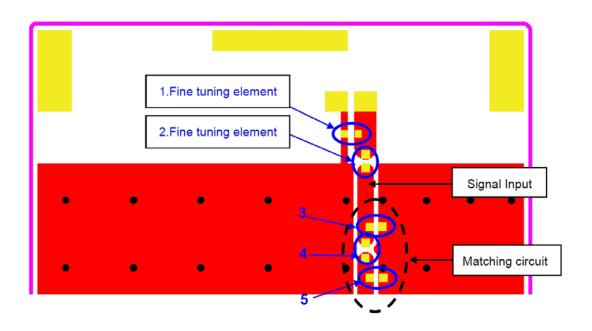


Transmission Line with 50Ω Impedance Characteristic

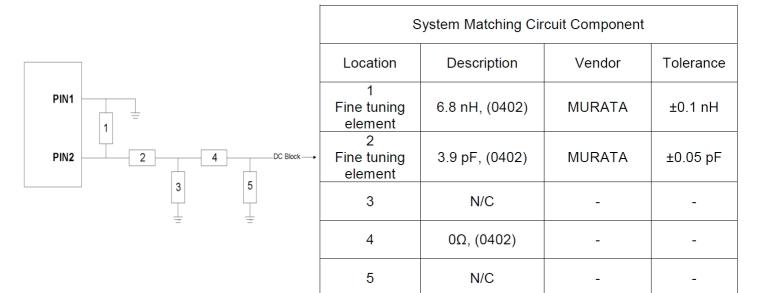




4. Frequency Tuning And Matching Circuit



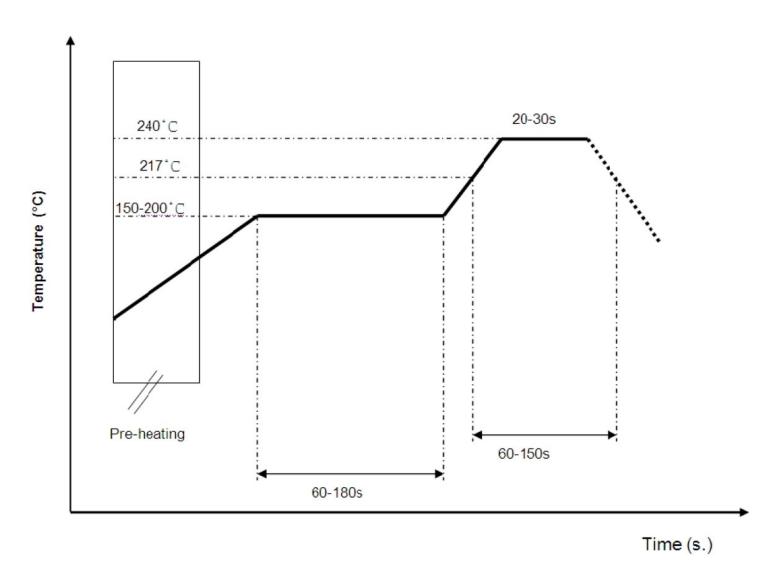
With the following recommended values of matching and tuning components, the covering frequency bands will be about $698\sim960 \& 1710\sim2690 \text{ MHz}$ at our standard 37x118.5 mm evaluation board.



*These are typical reference values which may need to be changed when circuit boards or part vendors are different.



5. Soldering Conditions

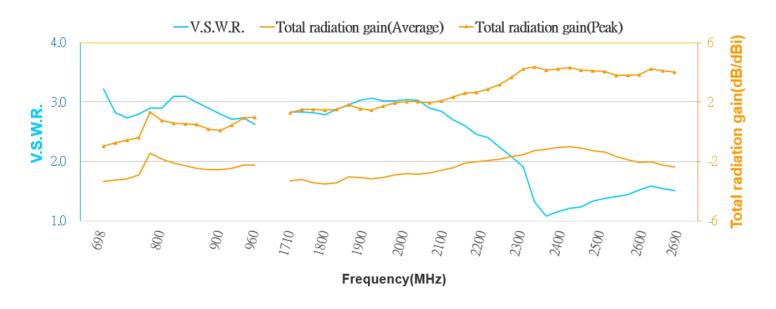


**Recommended solder paste alloy: SAC305(Sn96.5/Ag3/Cu0.5) Lead free solder paste.



6. Performance

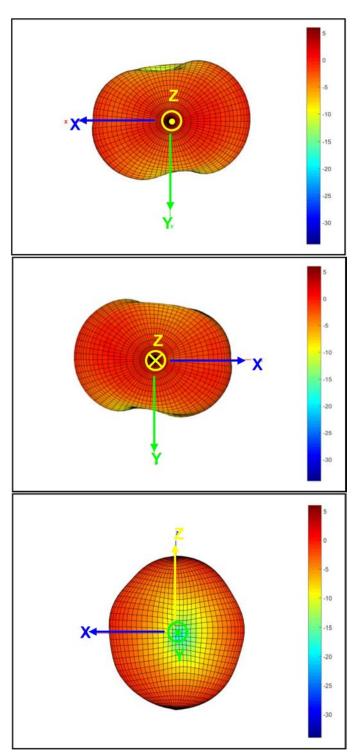
6.1 V.S.W.R., Average Gain, Peak Gain

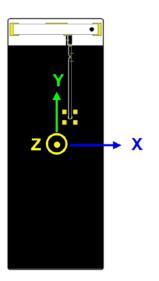




6.23D Radiation Pattern

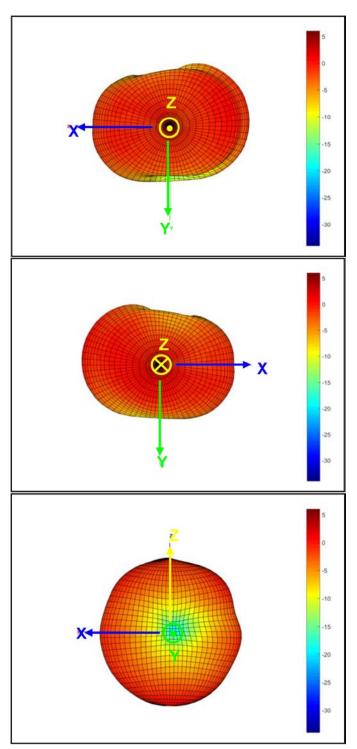
698~798 MHz 3D Gain Pattern @ 748 MHz (Unit : dBi)

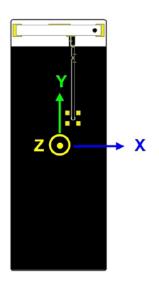






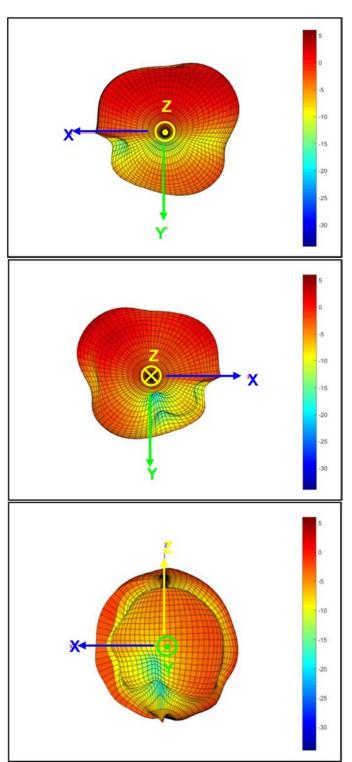
824~960 MHz 3D Gain Pattern @ 890 MHz (Unit : dBi)

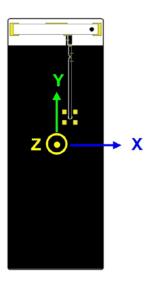






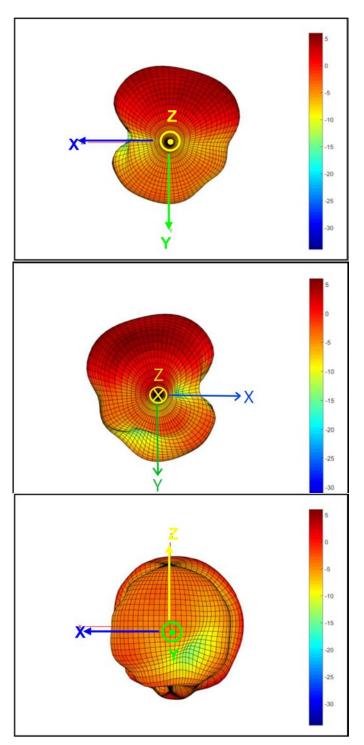
1710~2170 MHz 3D Gain Pattern @ 1950 MHz (Unit : dBi)

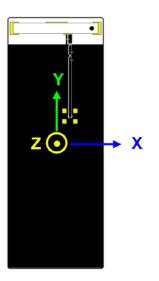






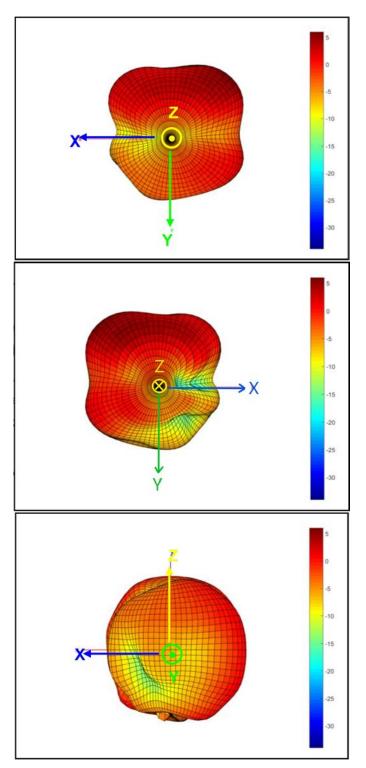
2300~2400 MHz 3D Gain Pattern @ 2350 MHz (Unit : dBi)

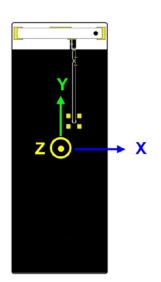






2490~2690 MHz 3D Gain Pattern @ 2590 MHz (Unit : dBi)

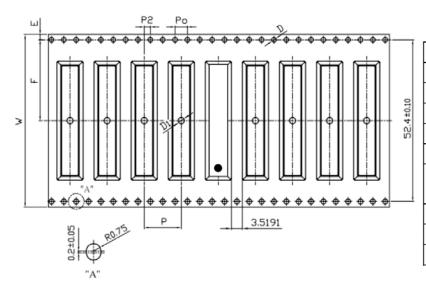






7. Packing

• Tape:



Feature	Specifications	Tolerances	
W	56.00	±0.30	
Р	12.00	±0.10	
E	1.75	±0.10	
F	26.20	±0.15	
P2	2.00	±0.15	
D	1.50	+0.10	
D	1.50	-0.00	
D1	2.00	±0.10	
Po	4.00	±0.10	
10Po	40.00	±0.20	

• Reel: 1,000 pcs

